

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3517808

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TETSUO NAKANO	05/29/2015
RECEIVING PARTY DATA	
Name:	KYOWA HAKKO BIO CO., LTD.
Street Address:	1-6-1, OHTEMACHI, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	100-8185
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14650229
CORRESPONDENCE DATA	
Fax Number:	(312)616-5700
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	LEYDIG, VOIT & MAYER, LTD.
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Address Line 2:	180 N. STETSON AVENUE
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ATTORNEY DOCKET NUMBER:	721012
NAME OF SUBMITTER:	JOHN KILYK, JR.
SIGNATURE:	/John Kilyk, Jr./
DATE SIGNED:	09/09/2015
Total Attachments: 2	
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source=Assignment_NAKANO#page2.tif	

ASSIGNMENT

WHEREAS, I/WE

Tetsuo NAKANO of c/o Head Office, KYOWA HAKKO BIO CO., LTD., 1-6-1, Ohtemachi, Chiyoda-ku, Tokyo 100-8185 Japan

hereinafter referred to as Assignor, have invented a certain invention entitled:

DOUBLE-STRANDED RIBONUCLEIC ACID FOR ADJUVANTS

for which invention an application (provisional or non-provisional) for a U.S. patent was filed on June 5, 2015, under U.S. Application No. 14/650,229, and

WHEREAS,

KYOWA HAKKO BIO CO., LTD., 1-6-1, Ohtemachi, Chiyoda-ku, Tokyo 100-8185 Japan

hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in, to, and under the invention described in the patent application, including the entire priority right derived from the application,

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

Assignor assigns and transfers to Assignee and Assignee's legal representatives, successors, and assigns the entire right, title, and interest in, to, and under the invention, the referenced patent application, other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, national and regional phase applications, petty patent applications, and utility model applications) that may be filed in the U.S. and/or any country foreign to the U.S. on the invention, the patents that may issue thereon, and the patents as may be modified as the result of applicable procedures (e.g., supplemental examinations, ex parte reexaminations, inter partes reexaminations, inter partes reviews, post-grant reviews, and oppositions),

Assignor conveys to the Assignee the right to make applications in Assignee's own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim priority to the referenced patent application and other such applications that may be filed in the U.S. or any country foreign to the U.S. on the invention under the Patent Cooperation Treaty, the Paris Convention, and any other international arrangements,

Assignor will not execute any writing or do any act conflicting with the terms of this assignment,

Assignor will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to pursue the patent applications identified herein, including, but not limited to, rendering all necessary assistance

in making applications for and obtaining patents that may issue thereon in the U.S. and any countries foreign to the U.S. on the invention, and in enforcing any rights accruing as a result of such applications or patents, by, for example, executing statements and other affidavits,

Assignor and Assignee agree the terms of this assignment shall bind, and inure to the benefit of, the legal representatives, successors, and assigns of all parties hereto,

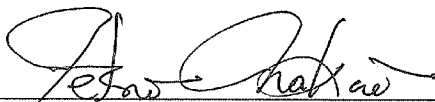
Assignor authorizes Assignee to insert in this assignment the number and filing date of the application if the number and filing date of the application are not recited herein at the time of execution of this assignment by any or all of the parties hereto,

Assignor and Assignee agree that U.S. law governs this assignment, and

Assignee acknowledges and accepts this assignment.

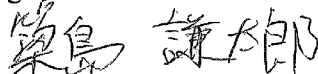
IN WITNESS WHEREOF, Assignor has hereunder set his/her hand on the date shown below.

Date May 29, 2015



Assignor: Tetsuo NAKANO

Date May 29, 2015



Witness: Kentaro YAMASHIMA

Date May 29, 2015



Witness: Tetsuo Matsushita

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